IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for Low V_{CEsat}
- 5 µs Short–Circuit Capability
- This is a Pb–Free Device

Typical Applications

- Motor Drive Inverters
- Industrial Switching
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	80 40	A
Diode Forward Current @ Tc = 25°C @ Tc = 100°C	١ _F	80 40	A
Diode Pulsed Current T _{PULSE} Limited by T _J Max	I _{FM}	160	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	160	A
Short–circuit withstand time $V_{GE} = 15 \text{ V}, V_{CE} = 400 \text{ V}, T_J \leq +150^{\circ}\text{C}$	t _{SC}	5	μs
Gate-emitter voltage	V _{GE}	±20	V
Transient gate–emitter voltage $(T_{PULSE} = 5 \ \mu s, D < 0.10)$		±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	417 208	W
Operating junction temperature range	TJ	–55 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

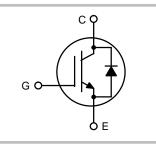
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

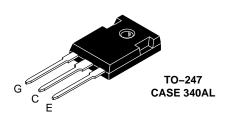


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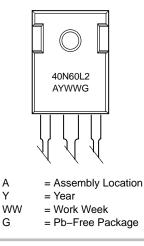
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40 A, 600 V V_{CEsat} = 1.65 V E_{OFF} = 0.28 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N60L2WG	TO–247 (Pb–Free)	30 Units / Rail

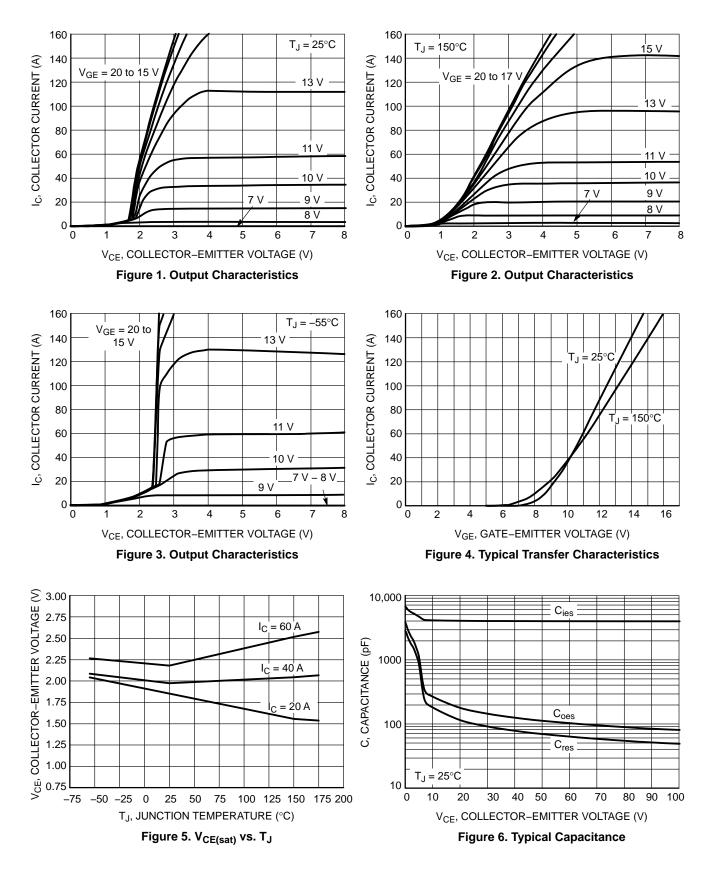
THERMAL CHARACTERISTICS

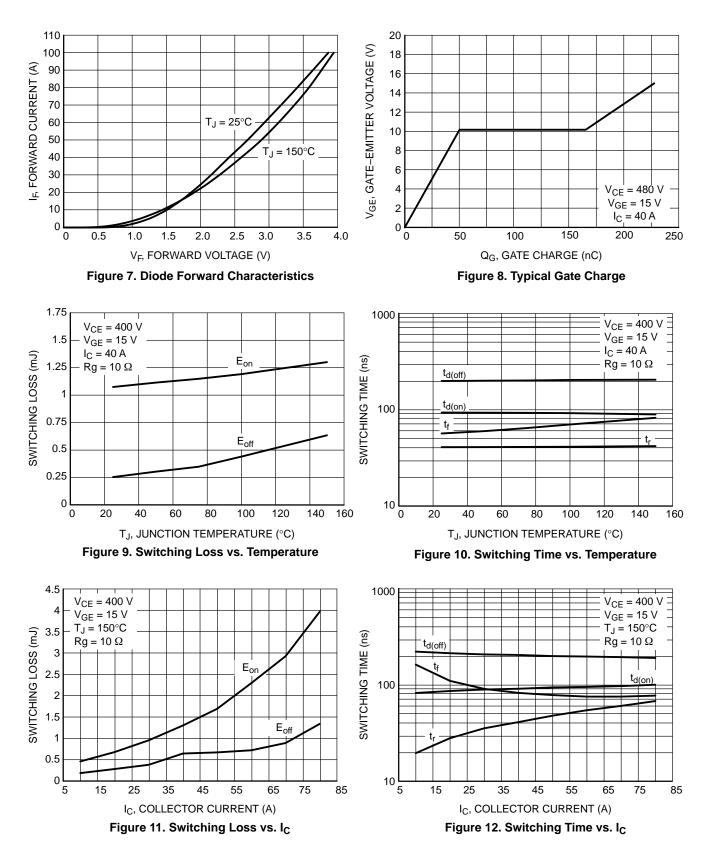
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.36	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	1.00	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

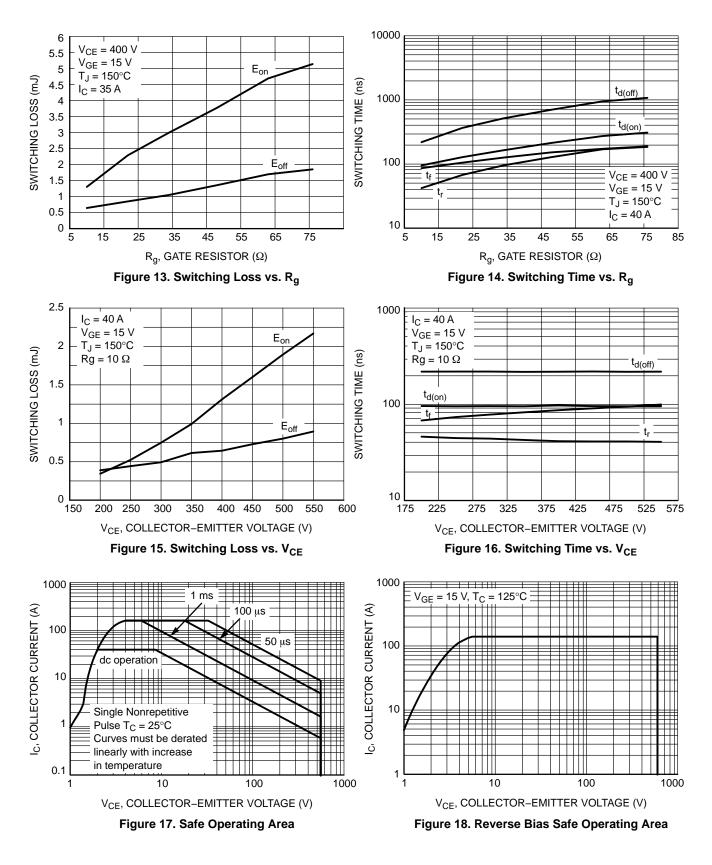
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

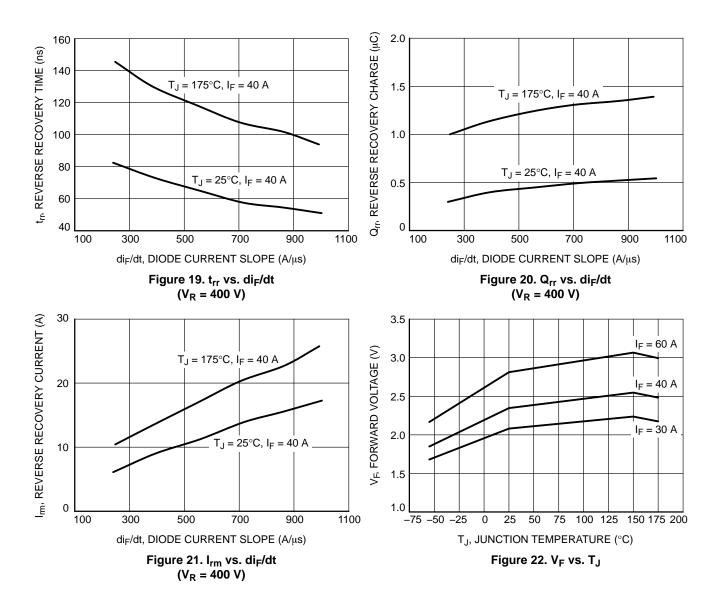
Parameter	Test Conditions	Symbol	Min	Тур	Мах	Unit
STATIC CHARACTERISTIC	·					
Collector–emitter breakdown voltage, gate–emitter short–circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	600	_	-	V
Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \text{ T}_{J} = 175^{\circ}\text{C}$	V _{CEsat}	-	1.65 1.90	1.90 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \mu\text{A}$	V _{GE(th)}	4.5	5.8	6.5	V
Collector–emitter cut–off current, gate– emitter short–circuited	$V_{GE} = 0 V, V_{CE} = 600 V$ $V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 175^{\circ}C$	ICES		_ 5.0	0.5 -	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	-	200	nA
DYNAMIC CHARACTERISTIC	·					
Input capacitance		Cies	_	5286	_	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	_	213	-	
Reverse transfer capacitance		C _{res}	-	147	-	
Gate charge total	$V_{CE} = 480 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \text{ V}_{GE} = 15 \text{ V}$	Qg	-	228	-	nC
Gate to emitter charge		Q _{ge}	-	50	-	
Gate to collector charge		Q _{gc}	-	115	-	
SWITCHING CHARACTERISTIC, INDUC						
Turn–on delay time		t _{d(on)}	-	98	-	ns
Rise time	1	t _r	-	42	-	
Turn–off delay time	$T_J = 25^{\circ}C$ $V_{CC} = 400 V, I_C = 40 A$	t _{d(off)}	_	213	-	
Fall time		t _f	_	60	-	
Turn-on switching loss	$R_g = 10 \Omega$ V _{GE} = 0 V/ 15 V	Eon	-	1.17	-	mJ
Turn–off switching loss	1	E _{off}	-	0.28	-	
Total switching loss	1	E _{ts}	-	1.45	-	
Turn–on delay time		t _{d(on)}	-	98	-	ns
Rise time		t _r	-	44	-	
Turn–off delay time	T _J = 150°C	t _{d(off)}	_	220	-	
Fall time	$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A}$	t _f	_	88	-	
Turn-on switching loss	$R_g = 10 \ \Omega$ V _{GE} = 0 V/ 15 V	Eon	-	1.45	-	mJ
Turn–off switching loss		E _{off}	-	0.68	-	
Total switching loss		E _{ts}	-	2.13	-	
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 40 A V _{GE} = 0 V, I _F = 40 A, T _J = 175°C	V _F		2.40 2.58	3.00 -	V
Reverse recovery time	$T_{J} = 25^{\circ}C$ $I_{F} = 40 \text{ A}, V_{R} = 200 \text{ V}$ $di_{F}/dt = 200 \text{ A}/\mu \text{s}$	t _{rr}	-	73	-	ns
Reverse recovery charge		Q _{rr}	_	282	-	nC
Reverse recovery current		I _{rrm}	-	6.7	-	A
Reverse recovery time	T 175°C	t _{rr}	_	160	-	ns
Reverse recovery charge	$T_{J} = 175 ^{\circ}C$ $I_{F} = 40 \text{ A}, V_{R} = 200 \text{ V}$ $di_{F}/dt = 200 \text{ A}/\mu \text{s}$	Q _{rr}	-	912	-	nC
Reverse recovery current		I _{rrm}	_	8.6	_	A

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.









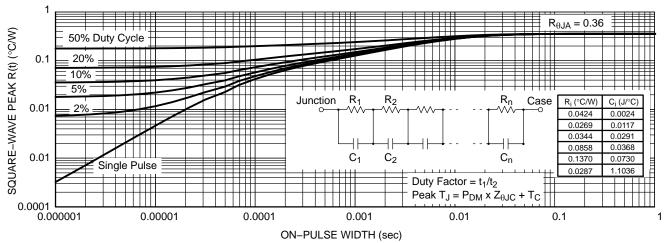


Figure 23. IGBT Die Self-heating Square-wave Duty Cycle Transient Thermal Response

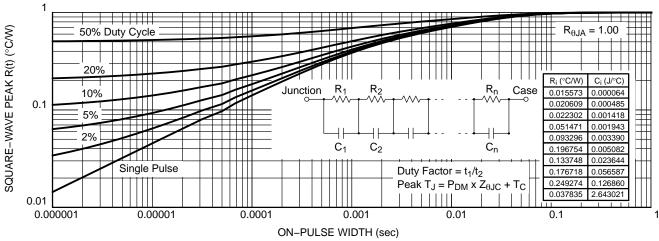
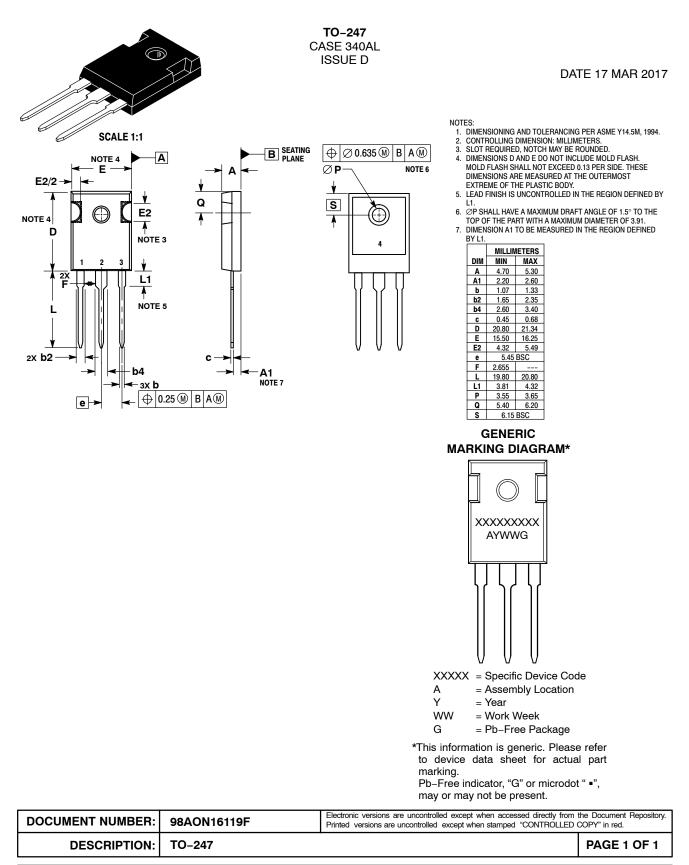


Figure 24. Diode Die Self-heating Square-wave Duty Cycle Transient Thermal Response

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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